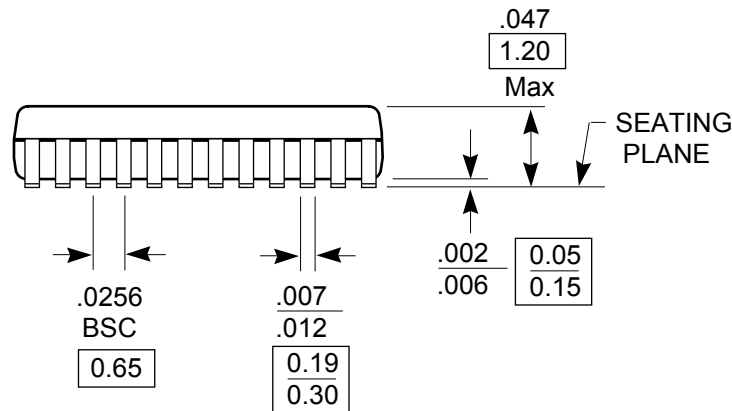
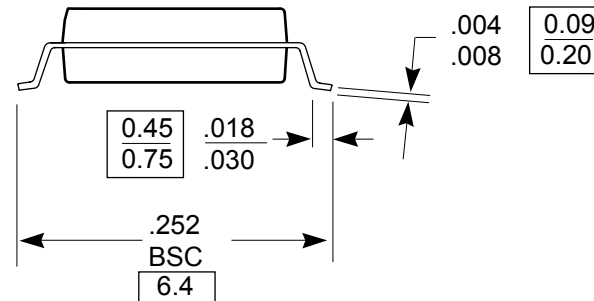
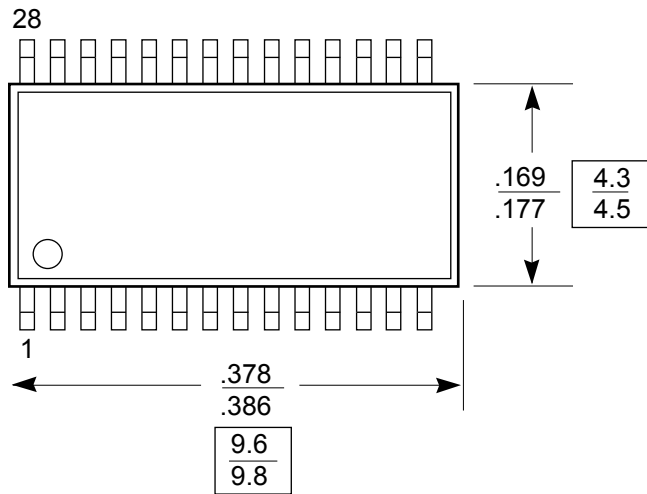


DOCUMENT CONTROL NO.
PD - 1313

REVISION: D
DATE: 03/09/05



Note:

1. Package Outline Exclusive of Mold Flash and Metal Burr
2. Controlling dimensions in millimeters
3. Ref: JEDEC MO-153F/AE



Pericom Semiconductor Corporation
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DESCRIPTION: 28-Pin, 173-Mil Wide, TSSOP

PACKAGE CODE: L